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Product Change Notification - JAON-13MHBC653 (Printer Friendly)

Date: 04 Jul 2016

Product Category: Touch Sensing Technologies

Notification subject: CCB 2662 and 2662.001 Initial Notice: Qualification of ANAP assembly site for selected products of the 0.18 um Global Foundries wafer technology available in 8L and 14L SOIC package.

Notification text: **PCN Status:**
Initial notification

Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of ANAP assembly site for selected products of the 0.18 um Global Foundries wafer technology available in 8L and 14L SOIC package.

Pre Change:

Assembled at MTAI assembly site

Post Change:

Assembled at MTAI or ANAP assembly site

Pre and Post Change Summary:

	Pre Change	Post Change	
Assembly Site	MTAI assembly site	MTAI assembly site	ANAP Assembly Site
Wire material	Au wire	Au wire	Au wire
Die attach material	8390A	8390A	8290
Molding compound material	G600	G600	G600
Lead frame material	C194	C194	C194

Impacts to Data Sheet:

None

Reason for Change:

To improve manufacturability by qualifying ANAP as an additional assembly site.

Change Implementation Status:

In Progress

Estimated Qualification Completion Date:

August 2016

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date.

Time Table Summary:

	July 2016				August 2016			
Workweek	27	28	29	30	31	32	33	34
Initial PCN Issue Date	X							
Qual Report Availability								X
Final PCN Issue Date								X

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

July 4, 2016: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

[PCN_JAON-13MHBC653_Qual_Plan.pdf](#)

[PCN_JAON-13MHBC653_Affected_CPN.pdf](#)

[PCN_JAON-13MHBC653_Affected_CPN.xlsx](#)

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